

## 30mm(1.2 INCH) 5x7 DOT MATRIX DISPLAY

Part Number: TA12-22CGKWA Green

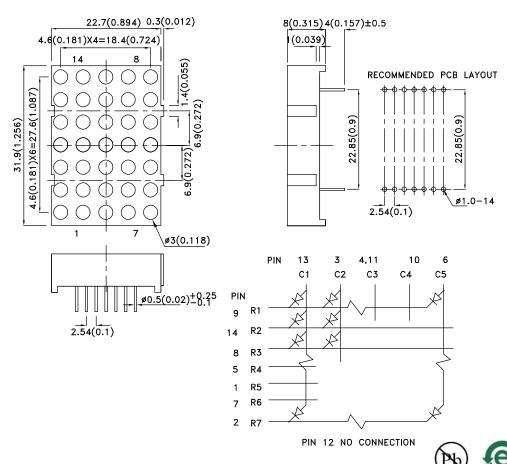
#### **Features**

- 1.2 inch matrix height .
- Dot size 3mm.
- Low current operation.
- High contrast and light output.
- Easy mounting on P.C. boards or sockets.
- Mechanically rugged.
- Standard:gray face, white dot.
- RoHS compliant.

## **Description**

The Green source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

# **Package Dimensions& Internal Circuit Diagram**



#### Notes:

- 1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.
- 2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 SPEC NO: DSAK2906
 REV NO: V.4A
 DATE: MAY/13/2013
 PAGE: 1 OF 6

 APPROVED: WYNEC
 CHECKED: Joe Lee
 DRAWN: F.Cui
 ERP: 1332000751

#### **Selection Guide**

Part No.	Dice	Lens Type	Iv (ucd) [1] @ 10mA		Description
			Min.	Тур.	·
TA12-22CGKWA	Green (AlGaInP)	White Diffused	31000	73000	Column Anode
			*14000	*27000	Column Anode

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	IF=20mA
λD [1]	Dominant Wavelength	Green	570		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	IF=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	2.1	2.5	V	IF=20mA
IR	Reverse Current	Green		10	uA	V <sub>R</sub> =5V

- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

## Absolute Maximum Ratings at TA=25°C

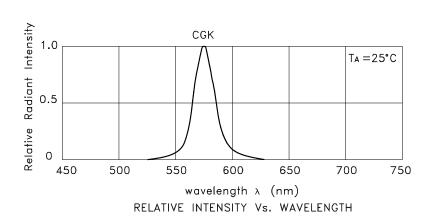
Parameter	Green	Units
Power dissipation	75	mW
DC Forward Current	30	mA
Peak Forward Current [1]	150	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	
.ead Solder Temperature[2] 260°C For 3-5 Seconds		

- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
  2. 2mm below package base.

SPEC NO: DSAK2906 **REV NO: V.4A** DATE: MAY/13/2013 PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED:** Joe Lee DRAWN: F.Cui ERP: 1332000751

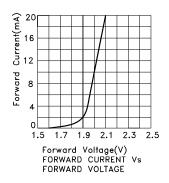
<sup>1.</sup> Luminous intensity/ luminous Flux: +/-15%.

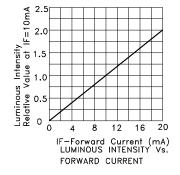
\*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

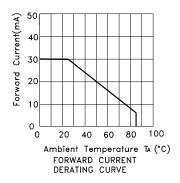


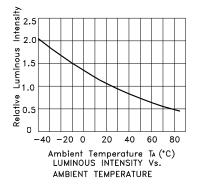
### Green

### TA12-22CGKWA





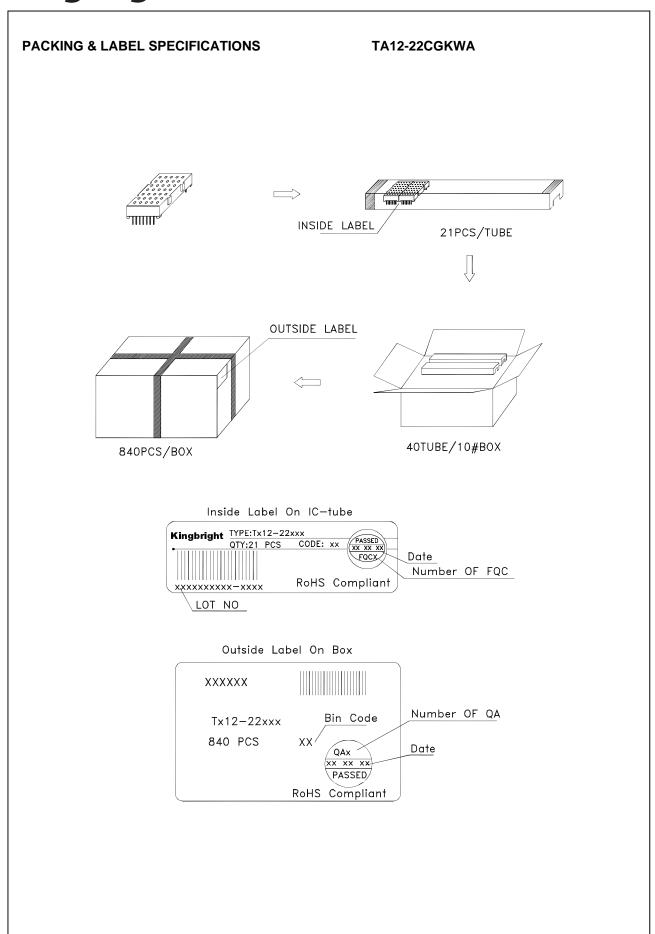




PAGE: 3 OF 6

ERP: 1332000751

SPEC NO: DSAK2906 REV NO: V.4A DATE: MAY/13/2013
APPROVED: WYNEC CHECKED: Joe Lee DRAWN: F.Cui



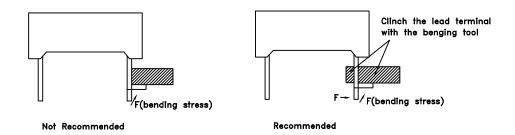
 SPEC NO: DSAK2906
 REV NO: V.4A
 DATE: MAY/13/2013
 PAGE: 4 OF 6

 APPROVED: WYNEC
 CHECKED: Joe Lee
 DRAWN: F.Cui
 ERP: 1332000751

### THROUGH HOLE DISPLAY MOUNTING METHOD

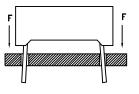
# Lead Forming

Do not bend the component leads by hand without proper tools. The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

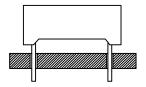


#### Installation

- 1. The installation process should not apply stress to the lead terminals.
- 2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.

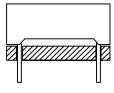


Not Recommended

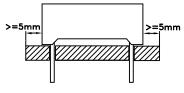


Recommended

3.The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



Not Recommended



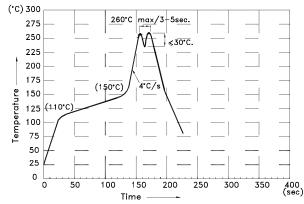
Recommended

SPEC NO: DSAK2906 APPROVED: WYNEC

REV NO: V.4A CHECKED: Joe Lee DATE: MAY/13/2013 DRAWN: F.Cui PAGE: 5 OF 6 ERP: 1332000751

#### DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



#### NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering , the PCB top-surface temperature should be kept below  $105^{\circ}C$
- 5.No more than once.

## Soldering General Notes:

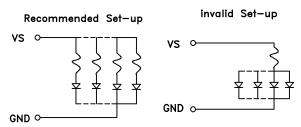
- 1. Through—hole displays are incompatible with reflow soldering.
- 2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

#### **CLEANING**

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

#### CIRCUIT DESIGN NOTES

- 1.Protective current—limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current—limiting resistor.



Detailed application notes are listed on our website. <a href="http://www.kingbright.com/application">http://www.kingbright.com/application</a> notes

SPEC NO: DSAK2906 REV NO: V.4A DATE: MAY/13/2013 PAGE: 6 OF 6

APPROVED: WYNEC CHECKED: Joe Lee DRAWN: F.Cui ERP: 1332000751